

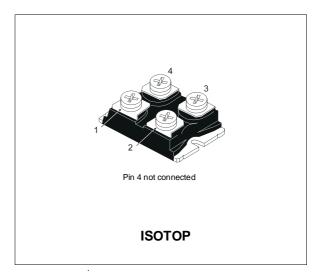
BUT30V

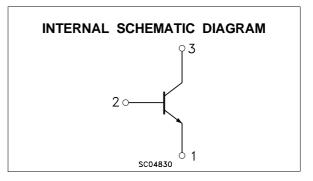
NPN TRANSISTOR POWER MODULE

- NPN TRANSISTOR
- HIGH CURRENT POWER BIPOLAR MODULE
- VERY LOW R_{th} JUNCTION CASE
- SPECIFIED ACCIDENTAL OVERLOAD AREAS
- FULLY INSULATED PACKAGE (U.L. COMPLIANT) FOR EASY MOUNTING
- LOW INTERNAL PARASITIC INDUCTANCE

APPLICATIONS:

- MOTOR CONTROL
- SMPS & UPS
- WELDING EQUIPMENT





ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit V | |
|-----------------------|---|------------|-----------|--|
| V _{CEV} | Collector-Emitter Voltage (V _{BE} = -5 V) | 200 | | |
| V _{CEO(sus)} | Collector-Emitter Voltage $(I_B = 0)$ | 125 | V | |
| V _{EBO} | Emitter-Base Voltage $(I_C = 0)$ | 7 | V | |
| Ι _C | Collector Current | 100 | A | |
| I _{CM} | Collector Peak Current (t _p = 10 ms) | 150 | A | |
| IB | Base Current | 20 | A | |
| I _{BM} | Base Peak Current (t _p = 10 ms) | 30 | A | |
| Ptot | Total Dissipation at $T_c = 25 \ ^{\circ}C$ | 250 | W | |
| Visol | Insulation Withstand Voltage (RMS) from All Four Terminals to External Heatsink | 2500 | | |
| T _{stg} | Storage Temperature | -55 to 150 | °C | |
| Tj | Max. Operating Junction Temperature | 150 | °C | |

THERMAL DATA

| R _{thj-case} | Thermal Resistance | Junction-case | Max | 0.5 | °C/W |
|-----------------------|--------------------|--------------------|------------|------|------|
| R _{thc-h} | Thermal Resistance | Case-heatsink With | Conductive | | |
| | Grease Applied | | Мах | 0.05 | °C/W |

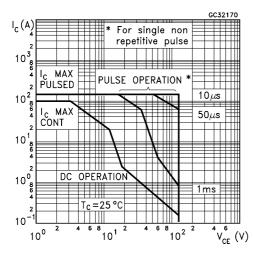
ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \, {}^{\circ}C$ unless otherwise specified)

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|--|---|---|------|-----------------------------|--------------------------|------------------|
| I _{CER} | Collector Cut-off Current (R _{BE} = 5 Ω) | $V_{CE} = V_{CEV}$ $V_{CE} = V_{CEV} \qquad T_c = 100 \ ^{\circ}C$ | | | 1 5 | mA mA |
| I _{CEV} | Collector Cut-off Current (V _{BE} = -5V) | $V_{CE} = V_{CEV}$ $V_{CE} = V_{CEV}$ $T_{c} = 100 \ ^{\circ}C$ | | | 1 4 | mA mA |
| Іево | Emitter Cut-off Current $(I_{C} = 0)$ | V _{EB} = 5 V | | | 1 | mA |
| $V_{CEO(sus)}^{*}$ | Collector-Emitter Sustaining Voltage (I _B = 0) | $I_{C} = 0.2 \text{ A}$ L = 25 mH V _{clamp} = 125 V | 125 | | | V |
| h _{FE} * | DC Current Gain | I _C = 100 A V _{CE} = 5 | | 27 | | |
| V _{CE(sat)} * | Collector-Emitter Saturation Voltage | $ \begin{array}{ll} I_{C}=50 \ A & I_{B}=2.5 \ A \\ I_{C}=50 \ A & I_{B}=2.5 \ A \\ T_{c}=100 \ A & I_{B}=10 \ A \\ I_{C}=100 \ A & I_{B}=10 \ A \\ \end{array} $ | | 0.45 0.55 0.7 0.9 | 0.9 1.2 0.9 1.5 | V V V V |
| V _{BE(sat)} * | Base-Emitter Saturation Voltage | | | 1.15 1.1 1.45 1.55 | 1.4 1.4 1.8 1.9 | V V V V |
| di _C /dt | Rate of Rise of On-state Collector | | 270 | 350 | | A/µs |
| V _{CE} (3 µs) | Collector-Emitter Dynamic Voltage | | | 2.7 | 3.5 | V |
| V _{CE} (5 µs) | Collector-Emitter Dynamic Voltage | Vcc = 300 V Rc = 1 Ω $I_{B1} = 15 A$ $T_c = 100 °C$ | | 2 | 2.5 | V |
| t _s t _f t _c | Storage Time Fall Time Cross-over Time | | | 1 0.1 0.2 | 2 0.2 0.35 | μs μs μs |
| V _{CEW} | Maximum Collector Emitter Voltage Without Snubber | | 125 | | | V |

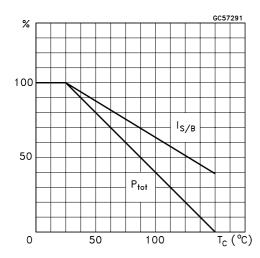
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* Pulsed: Pulse duration = $300 \,\mu$ s, duty cycle 1.5 %

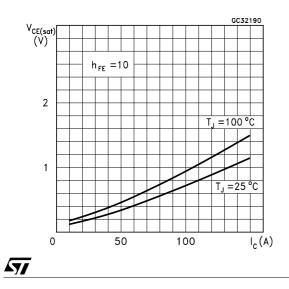
Safe Operating Areas



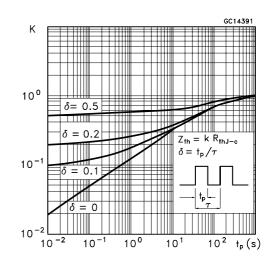
Derating Curve



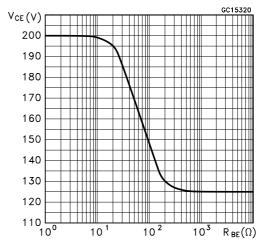
Collector Emitter Saturation Voltage



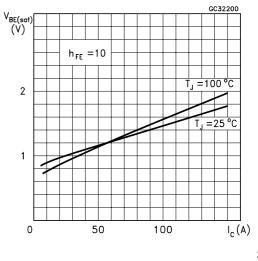
Thermal Impedance



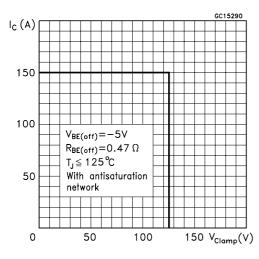
Collector-emitter Voltage Versus Base Emitter Resistance



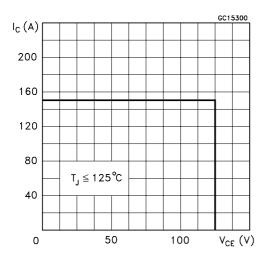




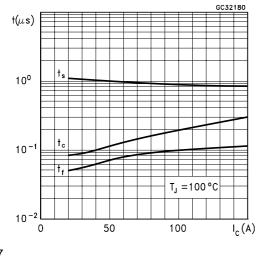
Reverse Biased SOA



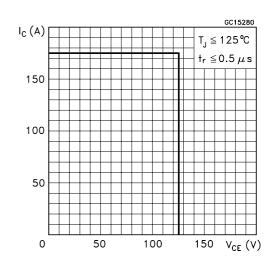
Reverse Biased AOA



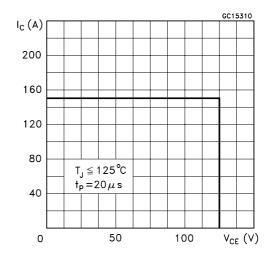
Switching Times Inductive Load

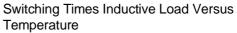


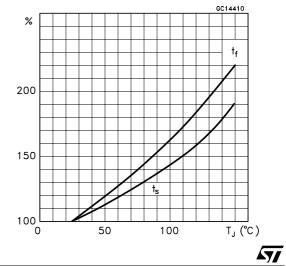
Foward Biased SOA



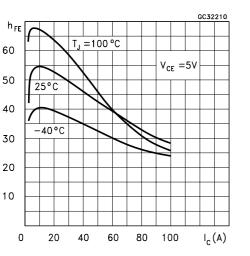




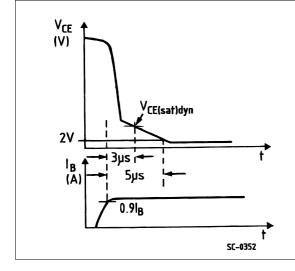




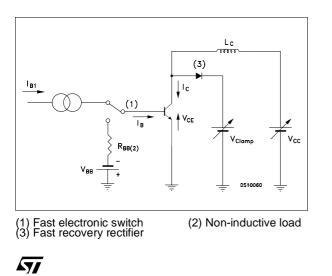
Dc Current Gain



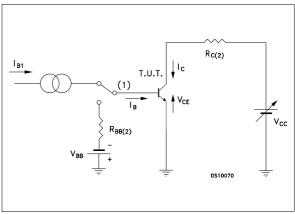
Turn-on Switching Waveforms





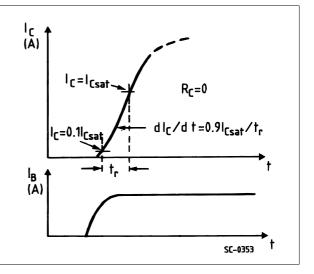


Turn-on Switching Test Circuit

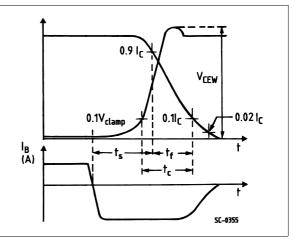


(1) Fast electronic switch



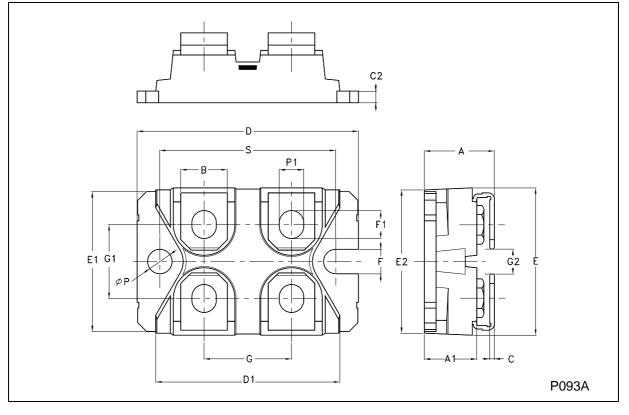


Turn-off Switching Waveforms



| DIM. | mm | | inch | | | |
|------|-------|------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| А | 11.8 | | 12.2 | 0.465 | | 0.480 |
| A1 | 8.9 | | 9.1 | 0.350 | | 0.358 |
| В | 7.8 | | 8.2 | 0.307 | | 0.322 |
| С | 0.75 | | 0.85 | 0.029 | | 0.033 |
| C2 | 1.95 | | 2.05 | 0.076 | | 0.080 |
| D | 37.8 | | 38.2 | 1.488 | | 1.503 |
| D1 | 31.5 | | 31.7 | 1.240 | | 1.248 |
| E | 25.15 | | 25.5 | 0.990 | | 1.003 |
| E1 | 23.85 | | 24.15 | 0.938 | | 0.950 |
| E2 | | 24.8 | | | 0.976 | |
| G | 14.9 | | 15.1 | 0.586 | | 0.594 |
| G1 | 12.6 | | 12.8 | 0.496 | | 0.503 |
| G2 | 3.5 | | 4.3 | 0.137 | | 1.169 |
| F | 4.1 | | 4.3 | 0.161 | | 0.169 |
| F1 | 4.6 | | 5 | 0.181 | | 0.196 |
| Р | 4 | | 4.3 | 0.157 | | 0.169 |
| P1 | 4 | | 4.4 | 0.157 | | 0.173 |
| S | 30.1 | | 30.3 | 1.185 | | 1.193 |





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